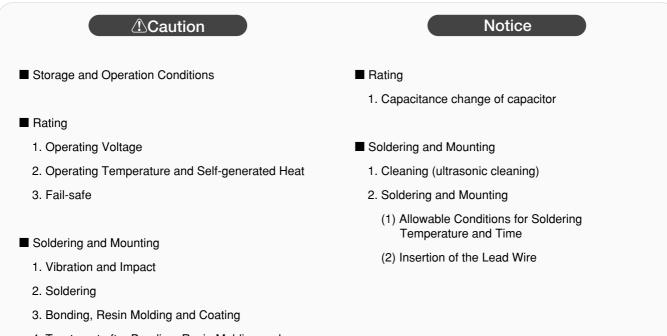
Caution/Notice



4. Treatment after Bonding, Resin Molding and Coating

Storage and Operation Conditions

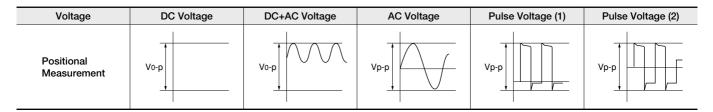
The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. Also avoid exposure to moisture. Before cleaning, bonding or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed 5 to 40 degrees centigrade and 20 to 70%. Use capacitors within 6 months after delivery.

Rating

1. Operating Voltage

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the Vp-p value of the applied voltage or the V0-p which contains DC bias within the rated voltage range.

When the voltage is applied to the circuit, starting or stopping may generate irregular voltage for a transit period because of resonance or switching. Be sure to use a capacitor with a rated voltage range that includes these irregular voltages. When DC-rated capacitors are to be used in input circuits from commercial power source (AC filter), be sure to use Safety Recognized Capacitors because various regulations on withstand voltage or impulse withstand established for all equipment should be taken into consideration.



2. Operating Temperature and Self-generated Heat

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself. When the capacitor is used in a high-frequency current, pulse current or similar current, it may have self-generated heat due to dielectric loss. In the case of "High Dielectric Constant Type Capacitors," applied voltage load should be such that self-generated heat is within 20 °C under the condition where the capacitor is subjected at an atmosphere temperature of 25 °C. Please contact us if self-generated heat occurs with "Temperature Compensating Type Capacitors".

3. Fail-Safe

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product. When measuring, use a thermocouple of small thermal capacity -K of Ø0.1mm under conditions where the capacitor is not affected by radiant heat from other components or wind from surroundings. Excessive heat may lead to deterioration of the capacitor's characteristics and reliability. Never attempt to perform measurement with the cooling fan running. Otherwise, accurate measurement cannot be ensured.



Continued from the preceding page.

Soldering and Mounting

1. Vibration and Impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.

2. Soldering

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

3. Bonding, Resin Molding and Coating

In case of bonding, molding or coating this product, verify that these processes do not affect the quality of the capacitor by testing the performance of the bonded, molded or coated product in the intended equipment.

In case the amount of application, dryness/ hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor may be damaged by the organic solvents and may result, worst case, in a short circuit.

The variation in thickness of adhesive or molding resin or coating may cause an outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

4. Treatment after Bonding, Resin Molding and Coating When the outer coating is hot (over 100 degrees centigrade) after soldering, it becomes soft and fragile, so please be careful not to give it mechanical stress.

FAILURE TO FOLLOW THE ABOVE CAUTIONS MAY RESULT, WORST CASE, IN A SHORT CIRCUIT AND CAUSE FUMING OR PARTIAL DISPERSION WHEN THE PRODUCT IS USED.



Notice

Rating

1. Capacitance change of capacitor

In case of F/X7R/X7S/X7T/X8L/Y5V/Z5U char. Capacitors have an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor is left on for a long time. Moreover, capacitance might change greatly depending on the surrounding temperature or an applied voltage.

Soldering and Mounting

1. Cleaning (ultrasonic cleaning)

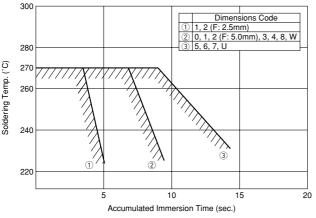
To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity: Output of 20 watts per liter or less. Rinsing time: 5 min. maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

2. Soldering and Mounting



Perform soldering within tolerance range (shaded portion).

- (2) Insertion of the Lead Wire
- When soldering, insert the lead wire into the PCB without mechanically stressing the lead wire.
- Insert the lead wire into the PCB with a distance appropriate to the lead space.



Туре	Temperature Compensating Type	High Dielectric	Constant Type	
Rated Voltage	DC50V, DC100V	DC50V	DC100V	
Dimensions Code Temp. Char.	X8G	X	8L	
0	- (<u>8</u> 102J	8 104K	8 103K (M 224 K18	
1				
2	_	(DH 105) K58		
3, W	_	(M 335) K58	_	
Temperature Characteristics	Marked with code (X8G, X8L cha	r.: 8)		
Nominal Capacitance	Marked with 3 figures			
Capacitance Tolerance	Marked with code			
Rated Voltage	Marked with code (DC50V: 5, DC100V: 1) A part is omitted (Please refer to the marking example.)			
Manufacturer's Identification Marked with M A part is omitted (Please refer to the marking example.)				



RH Series 150°C max. (for Automotive) Specifications and Test Methods

	o. AEC-Q200 Test Item		Specification					
٩o.			Temperature Compensating Type (Char. X8G)	High Dielectric Constant Type (Char. X8L)	AEC-Q200 Test Method			
1	Pre-and P Electrical	ost-Stress Test		-	-			
	High Temperature Exposure (Storage)		The measured and observed ch specifications in the following ta					
		Appearance	No defects or abnormalities					
2		Capacitance Change	Within ±3% or ±0.3pF (Whichever is larger)	Within ±12.5%	Sit the capacitor for 1,000±12h at 150±3°C. Let sit for 24±2h at room temperature, then measure.			
		Q/D.F.	Q≧350	0.04 max.				
		I.R.	More than 1,000M Ω or 50M Ω \cdot μ	uF (Whichever is smaller)				
	Temperat Cycling	ure	The measured and observed ch specifications in the following ta		Perform the 1,000 cycles according to the four heat treatments listed in the following table. Let sit for 24±2h at *room condition,			
		Appearance	No defects or abnormalities exc coating	ept color change of outer	then measure. Step 1 2 3 4			
3		Capacitance Change	Within ±5% or ±0.5pF (Whichever is larger)	Within ±12.5%	Temp. (°C) -55+0/-3 Room Temp. 150+3/-0 Room Temp. Time (min.) 15±3 1 15±3 1			
		Q/D.F.	Q≧350	0.05 max.	•Pretreatment Perform the heat treatment at 150+0/-10°C for 60±5 min and			
		I.R.	1,000MΩ or 50MΩ \cdot µF min. (W	hichever is smaller)	then let sit for 24±2h at *room condition. (for Char. X8L)			
	Moisture Resistanc	e	The measured and observed ch specifications in the following ta		Apply the 24h heat (25 to 65°C) and humidity (80 to 98%) treatment shown below, 10 consecutive times.			
		Appearance	No defects or abnormalities		Let sit for 24±2h at *room condition, then measure.			
	-	Capacitance Change	Within ±5% or ±0.5pF (Whichever is larger)	Within ±12.5%	Humidity Humidity Humidity Humidity Humidity (°C) 90-98% 80-98% 90-98% 80-98% 90-98% 70 65 64 64 7 1 64 7			
		Q/D.F.	Q≧200	0.05 max.				
4		I.R.	500MΩ or 25MΩ · μF min. (Whichever is smaller)		40 40 40 40 40 40 40 40 40 40			
	Biased Hu	Humidity The measured and observed characteristics should satisfy the specifications in the following table.		-	Apply the rated voltage and DC1.3+0.2/-0V (add 6.8k Ω resisto at 85±3°C and 80 to 85% humidity for 1.000±12h.			
		Appearance	No defects or abnormalities		Remove and let sit for 24±2h at *room condition, then measure.			
5		Capacitance Change	Within ±5% or ±0.5pF (Whichever is larger)	Within ±12.5%	The charge/discharge current is less than 50mA. Pretreatment 			
		Q/D.F.	Q≧200	0.05 max.	Perform the heat treatment at 150+0/-10°C for 60±5 min and			
		I.R.	500M Ω or 25M $\Omega\cdot\mu F$ min. (White	chever is smaller)	then let sit for 24±2h at *room condition. (for Char. X8L)			
	Operation	nal Life	The measured and observed ch specifications in the following ta		Apply 150% of the rated voltage for 1,000±12h at 150±3°C.			
		Appearance	earance No defects or abnormalities except color change of outer coating		Let sit for 24±2h at *room condition, then measure. The charge/discharge current is less than 50mA.			
6		Capacitance Change	Within ±3% or ±0.3pF (Whichever is larger)	Within ±12.5%	•Pretreatment Apply test voltage for 60±5 min at test temperature.			
		Q/D.F.	Q≧350	0.04 max.	Remove and let sit for 24±2h at *room condition. (for Char. X8L)			
		I.R.	1,000M Ω or 50M Ω \cdot μ F min. (W	hichever is smaller)				
		External Visual No defects or abnormalities						
7	External \	/isual	No defects or abnormalities		Visual inspection			
7 8		/isual Dimension			Visual inspection Using calipers and micrometers.			

 * "room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmosphere pressure: 86 to 106kPa

Continued on the following page.



RH Series 150°C max. (for Automotive) Specifications and Test Methods

Continued from the preceding page.

	o. AEC-Q200 Test Item		Specification Temperature Compensating Type (Char. X8G) High Dielectric Constant Type (Char. X8L)		AEC-Q200 Test Method		
No.							
		Appearance	No defects or abnormalities		Per MIL-STD-202 Method 215		
		Capacitance	Within the specified tolerance		Solvent 1: 1 part (by volume) of isopropyl alcohol 3 parts (by volume) of mineral spirits		
10	Resistance	Q/D.F.	Q≧1,000	0.025 max.	Solvent 2: Terpe		ineral spints
10	to Solvents	I.R.	More than 10,000M Ω or 500M Ω	· µF (Whichever is smaller)	Solvent 2: 42 parts (by volume) of water 1 part (by volume) of propylene glycol monomethyl ether 1 part (by volume) of monoethanolamine		pylene glycol
		Appearance	No defects or abnormalities				d be applied along 3
11	Mechanical	Capacitance	Within the specified tolerance				est specimen (18 shocks). alf-sine and should
	Shock	Q/D.F.	Q≧1,000	0.025 max.			1,500G and velocity
		Appearance	No defects or abnormalities				a simple harmonic motior
		Capacitance	Within the specified tolerance				ne frequency being varied imits of 10 and 2 000Hz
12	Vibration	Q/D.F.	Q≥1,000	0.025 max.	uniformly between the approximate limits The frequency range, from 10 to 2,000H should be traversed in approximately 20 should be applied for 12 items in each 3 directions (total of 36 times).		00Hz and return to 10Hz, 20min. This motion
	Resistance to Soldering Heat		The measured and observed characteristics should satisfy the specifications in the following table.		The lead wire is immersed in the melted solder 1.5 to 2mm from the main body at 260±5°C for 10±1s. The specified items		
		Appearance	No defects or abnormalities				
13		Capacitance Change	Within ±2.5% or ±0.25pF (Whichever is larger)	Within ±7.5%	are measured after 24±2h.		
		Dielectric Strength (Between Terminals)	No defects		 Pretreatment Perform the heat treatment at 150+0/-10°C for 60±5 min and then let sit for 24±2h at *room condition. (for Char. X8L) 		
	Thermal S	Shock	The measured and observed characteristics should satisfy the specifications in the following table. No defects or abnormalities		Perform the 300 cycles according to the two heat treatments listed in the following table (Maximum transfer time is 20s.). Let sit for 24±2h at *room condition, then measure.		
		Appearance					
14		Capacitance	Within ±5% or ±0.5pF	Within ±12.5%	Step	1	2
		Change	(Whichever is larger)	VVI(IIII1 ± 12.378	Temp. (°C) Time (min.)	-55+0/-3 15±3	150+3/-0 15±3
		Q/D.F.	Q≧350	0.05 max.	•Pretreatment		
		I.R.	1,000M Ω or 50M Ω · µF min. (Whichever is smaller)		Perform the heat treatment at 150+0/-10°C for 60±5min then let sit for 24±2h at *room condition. (for Char. X8L)		
		Appearance	No defects or abnormalities				
15	ESD	Capacitance	Within the specified tolerance		Per AEC-Q200-00	74	
10	LOD	Q/D.F.	Q≧1,000	0.025 max.		er AEC-Q200-004	
		I.R.	More than 10,000M Ω or 500M Ω	· µF (Whichever is smaller)			
16	16 Solderability		Solderability Lead wire should be soldered with uniform coating on the axial direction over 95% of the circumferential direction.		(JIS-K-8101) and propotion) and the	rosin (JIS-K-5902) en into molten sold n cases the depth o	into a solution of ethanol (25%rosin in weight er (JIS-Z-3282) for f dipping is up to about
						ree Solder (Sn-3.0 or H63A Eutectic S	

* "room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmosphere pressure: 86 to 106kPa

Continued on the following page.



RH Series 150°C max. (for Automotive) Specifications and Test Methods

Continued from the preceding page.

_			anig page:	_				
			Specification			_		
No.	AEC-Q200	Test Item	Temperature Compensating Type (Char. X8G) High Dielectric Constant Type (Char. X8L)		AEC-Q200 Test Method			
		Appearance	No defects or a	bnormalities		Visual inspection.		
		Capacitance	Within the specified tolerance			The capacitance, Q/D.F. should frequency and voltage shown in		
		Q/D.F.	Q≧1,000		0.025 max.	Char. Nominal Cap. Free X8G C≤1,000pF 1±0 X8G C>1000pF 1±0	Voltage 0.1MHz AC0.5 to 5V (r.m.s.) 0.1kHz AC1±0.2V (r.m.s.) 0.1kHz AC1±0.2V (r.m.s.)	
		Insulation Resistance	Room Temperature	10,000MΩ or 5 (Whichever is s	-	The insulation resistance should DC voltage not exceeding the ra- temperature and humidity and v (Charge/Discharge current ≤ 50	ated voltage at normal vithin 2min. of charging.	
17	Electrical Charac-	(I.R.)	High Temperature	100MΩ or 5MΩ (Whichever is s	•	The insulation resistance should a DC voltage not exceeding the temperature and humidity and v (Charge/Discharge current ≤ 50	rated voltage at normal vithin 2min. of charging.	
terization	terization		Between Terminals	No defects or a	bnormalities	The capacitor should not be damaged when DC voltage of 300% of the rated voltage (for Char. X8G) or DC voltage of 250% of the rated voltage (for Char. X8L) is applied between the terminations for 1 to 5 seconds. (Charge/Discharge current ≤ 50mA.)		
		Dielectric Strength	Body Insulation	No defects or a	bnormalities	The capacitor is placed in a corr with metal balls of 1mm diameter that each terminal, short-circuit approximately 2mm from the ba and 250% of the rated DC volta impressed for 1 to 5 seconds between capacitor terminals and metal balls. (Charge/Discharge current \leq 50	er so is kept ulls, ge is d	
18	Terminal	Tensile Strength	Termination not to be broken or loosened		As in the figure, fix the capacito apply the force gradually to eac in the radial direction of the cap until reaching 10N and then kee force applied for 10±1 seconds.	h lead		
Streng	Strength	Bending Strength	Termination not to be broken or loosened		Each lead wire should be subject be bent 90° at the point of egrees then returned to the original pose opposite direction at the rate of	ss in one direction. Each wire is sition and bent 90° in the		
						The capacitance change should each specified temperature step		
						Step	Temperature (°C)	
				if a d			25±2	
			Within the spec Tolerance.	Within the specified		2 3	-55±3 25±2	
	Capacitar	nce	(Table A) Within ±		Within ±15%	4	150±3	
9	Temperat		. ,		(Temp. Range: -55 to +125°C) Within +15/-40%	5	25±2	
		acteristics Capacitance Drift is within Within		(Temp. Range: +125 to +150°C)	The temperature coefficient or t change is determined using the step 3 as a reference. •Pretreatment Perform the heat treatment at then let sit for 24±2h at *room Perform the initial measureme	capacitance measured in 150+0/-10°C for 60±5 min and condition.		

* "room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmosphere pressure: 86 to 106kPa

Table A

Char.	Nominal Valuas	Capacitance Change from 25°C (%)					
	Nominal Values (ppm/°C) *	–55°C		–30°C		–10°C	
		Max.	Min.	Max.	Min.	Max.	Min.
X8G	0±30	0.58	-0.24	0.40	-0.17	0.25	-0.11

* Nominal values denote the temperature coefficient within a range of 25°C to 150°C.



Packaging

Two types of packaging for monolithic ceramic capacitors are available.

1. Bulk Packaging

Minimum Quantity

Dimensions Code	Dimensions (L×W)	Minimum Quantity (pcs./Bag)*	
0	3.6×3.5mm or 4.0×3.5mm or 5.0×3.5mm (Depends on Part Number)		
1	4.0×3.5mm or 4.5×3.5mm or 5.0×3.5mm (Depends on Part Number)		
2	5.0×3.5mm or 5.5×4.0mm or 5.7×4.5mm (Depends on Part Number)		
3	5.0×4.5mm or 5.5×5.0mm or 6.0×5.5mm (Depends on Part Number)	500	
4	7.5×5.5mm	500	
5 7.5×7.5mm or 7.5×8.0mm (Depends on Part Number)			
6	10.0×10.0mm		
8	7.5×5.5mm		
7	12.5×12.5mm	100	
U	7.7×12.5mm or 7.7×13.0mm (Depends on Part Number)	200	
W	5.5×7.5mm or 6.0×8.0mm (Depends on Part Number)	500	

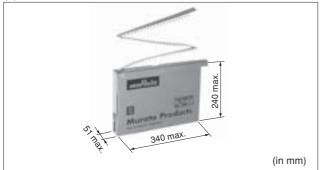
Please order with an integral multiple of the minimum quantity above.

* Minimum Quantity may change depends on part number.

Please check our website 'Product details'.

2. Tape Carrier Packaging

(1) Dimensions of Ammo Pack



(2) Minimum Quantity

Dimensions Code	Dimensions (L×W)	Minimum Quantity (pcs./Ammo Pack)*	
0	3.6×3.5mm or 4.0×3.5mm or 5.0×3.5mm (Depends on Part Number)		
1	4.0×3.5mm or 4.5×3.5mm or 5.0×3.5mm (Depends on Part Number)		
2	5.0×3.5mm or 5.5×4.0mm or 5.7×4.5mm (Depends on Part Number)	2000	
3	5.0×4.5mm or 5.5×5.0mm or 6.0×5.5mm (Depends on Part Number)		
4	7.5×5.5mm		
5	7.5×7.5mm or 7.5×8.0mm (Depends on Part Number)	2000	
6	10.0×10.0mm	1500	
8	7.5×5.5mm	- 1500	
U	7.7×12.5mm or 7.7×13.0mm (Depends on Part Number)	1000	
W	5.5×7.5mm or 6.0×8.0mm (Depends on Part Number)	1500	

Please order with an integral multiple of the minimum quantity above.

* Minimum Quantity may change depends on part number.

Please check our website 'Product details'.

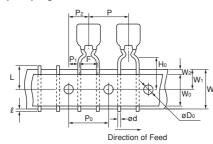
"Minimum Quantity" means the numbers of units of each delivery or order. The quantity should be an integral multiple of the "minimum quantity". (Please note that the actual delivery quantity in a package may change sometimes.)



Continued from the preceding page.

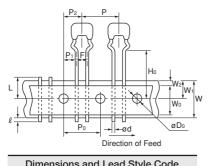
Taping Dimensions

Inside Crimp Taping

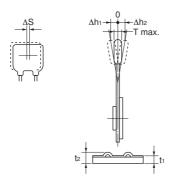


Dimensions and Lead Style Code
Dimensions and Lead Style Code
0M1
1M1
2M1
2M2
3M1
3M2
4M1
4M2
8M1
8M2
WM1

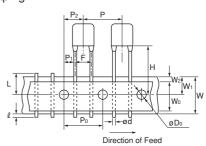
Outside Crimp Taping



Dimensions and Lead Style Code
0S1
1S1
2S1
2S2
3S1
3S2



Straight Taping



Dimensions and Lead Style Code
1DB
2DB
3DB
5E1
5E2
6E1
6E2
UE1

Item	Code	Dimensions (mm)		
Pitch of Component	P	12.7±1.0		
Pitch of Sprocket Hole	P0		12.7±0.2	
Lead Spacing	F	2.5 ^{+0.4} _{-0.2} (DB) (S1) (S2)		
			5.0 ^{+0.6} -0.2	
Length from Hole Center to Component Center	P2		6.35±1.3	
	D.		3.85±0.7	
Length from Hole Center to Lead	P1	5.1±0	.7 (DB) (S1) (S2)	
Leau	254±1.	5 Total length	of components pitch \times 20	
Body Dimension	[Depends o	n Part Number	
Deviation Along Tape, Left or Right Defect	ΔS		±2.0	
Carrier Tape Width	W	18.0±0.5		
Position of Sprocket Hole	W1	9.0+0		
Lead Distance between	Ho	16.0±0.5 (M1) (S1)		
Reference and Bottom Plane		20.0±0.5 (M2) (S2)		
For Straight Lead Type	Н	20±0.5 (E2),17.5±0.5 (E1),16±0.5 (DE		
Diameter of Sprocket Hole	Do		4.0±0.1	
Lead Diameter	d		0.5±0.05	
Total Tape Thickness	t1		0.6±0.3	
Total Thickness of Tape and Lead Wire	t2		1.5 max.	
Body Thickness	Т	Depend	ls on Part Number	
		2.0 max.	Dimensions Code: W, U	
Deviation Across Tape	Δh_1 Δh_2	1.5 max.	RHD Series	
		1.0 max.	except as above	
Portion to Cut in Case of Defect	L	11.0+0		
Protrusion Length	l	0.5 max.		
Hold Down Tape Width	Wo		9.5 min.	
Hold Down Tape Position	W2		1.5±1.5	
Coating Extension	0	Depends o	n Dimensions	

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